

LOW-VOLTAGE DUAL DIFFERENTIAL 1:5 LVPECL CLOCK DRIVER

Check for Samples: [CDCLVP215](#)

FEATURES

- 2× One Differential Clock Input Pair LVPECL to 5 Differential LVPECL Clock Outputs
- Fully Compatible With LVPECL/LVECL
- Supports a Wide Supply Voltage Range From 2.375 V to 3.8 V
- Open Input Default State
- Low-Output Skew (Typ 15 ps) for Clock-Distribution Applications
- V_{BB} Reference Voltage Output for Single-Ended Clocking
- Available in the QFN32 Package
- Frequency Range From DC to 3.5 GHz
- Pin-to-Pin Compatible With the MC100 Series EP111, LVEP210, ES6111, LVEP111

APPLICATIONS

- Designed for Driving 50-Ω Transmission Lines
- High Performance Clock Distribution

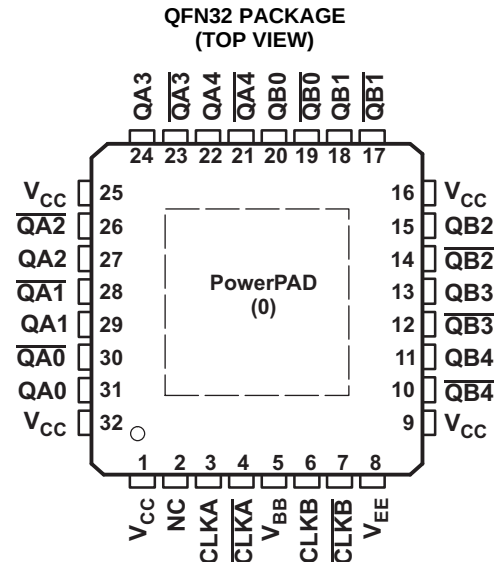
DESCRIPTION

The CDCLVP215 clock driver distributes two times one differential clock pair of LVPECL, (CLKA, CLKB) to 5 pairs of differential LVPECL clock (QA0..QA4, QB0..QB4) outputs with minimum skew for clock distribution. The CDCLVP215 specifies low output-to-output skew. The CDCLVP215 is specifically designed for driving 50-Ω transmission lines. When an output pair is not used, leaving it open is recommended to reduce power consumption. If only one of the output pairs is used, the other output pair must be identically terminated to 50 Ω.

The V_{BB} reference voltage output is used if single-ended input operation is required. In this case, the V_{BB} pin should be connected to CLKA or CLKB and bypassed to GND via a 10-nF capacitor.

However, for high-speed performance up to 3.5 GHz, the differential mode is strongly recommended.

The CDCLVP215 is characterized for operation from –40°C to 85°C.



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PowerPAD is a trademark of Texas Instruments.

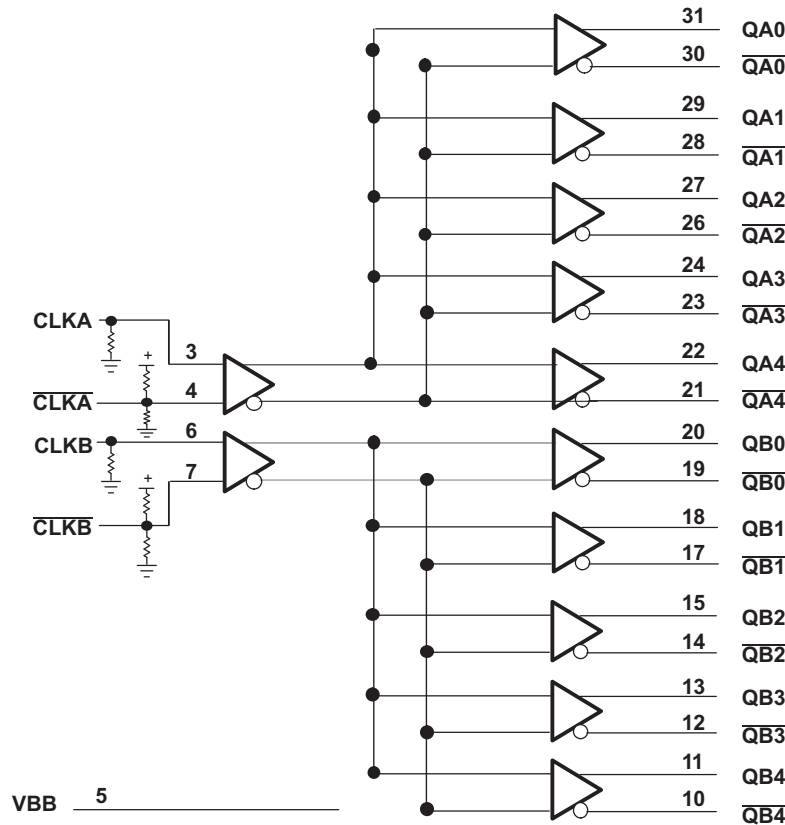
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ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.



PIN FUNCTIONS

PIN		DESCRIPTION
NAME	NO.	
NC	2	Not connected
CLKA, $\overline{\text{CLKA}}$	3, 4	Differential LVECL/LVPECL input pair
CLKB, $\overline{\text{CLKB}}$	6, 7	Differential LVECL/LVPECL input pair
Q [A0:A4]	22, 24, 27, 29, 31	LVECL/LVPECL clock outputs, these outputs provide low-skew copies of CLKA.
$\overline{\text{Q}}$ [A0:A4]	21, 23, 26, 28, 30	LVECL/LVPECL complementary clock outputs, these outputs provide low-skew copies of CLKA.
Q [B0:B4]	11, 13, 15, 18, 20	LVECL/LVPECL clock outputs, these outputs provide low-skew copies of CLKB.
$\overline{\text{Q}}$ [B0:B4]	10, 12, 14, 17, 19	LVECL/LVPECL complementary clock outputs, these outputs provide low-skew copies of CLKB.
V_{BB}	5	Reference voltage output for single-ended input operation
V_{CC}	1, 9, 16, 25, 32	Supply voltage
V_{EE}	8	Device ground or negative supply voltage in ECL mode
PowerPAD™	0	The PowerPAD of the QFN32 package is thermally connected to the die to improve the heat transfer out of the package. This pad is connected to V_{EE} .

- CLK_n pull down resistor 75 k Ω
- $\overline{\text{CLK}}_n$ pull up resistor 37.5 k Ω
- $\overline{\text{CLK}}_n$ pull down resistor 50 k Ω

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)

		VALUE	UNIT
V_{CC}	Supply voltage (relative to V_{EE})	–0.3 to 4.6	V
V_I	Input voltage	–0.3 to $V_{CC} + 0.5$	V
V_O	Output voltage	–0.3 to $V_{CC} + 0.5$	V
I_{IN}	Input current	±20	mA
V_{EE}	Negative supply voltage (relative to V_{CC})	–4.6 to 0.3	V
I_{BB}	Sink/source current	–1 to 1	mA
I_O	DC output current	–50	mA
T_{stg}	Storage temperature range	–65 to 150	°C

RECOMMENDED OPERATING CONDITIONS

		MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage (relative to V_{EE})	2.375	2.5/3.3	3.8	V
T_A	Operating free-air temperature	–40		85	°C

PACKAGE THERMAL IMPEDANCE

		TEST CONDITION	MIN	MAX	UNIT
θ_{JA}	Thermal resistance junction to ambient ⁽¹⁾	0 LFM		49	°C/W
		150 LFM		37	°C/W
		250 LFM		36	°C/W
		500 LFM		32	°C/W
θ_{JC}	Thermal resistance junction to case			19	°C/W

(1) According to JESD 51-7 standard.

LVECL DC ELECTRICAL CHARACTERISTICS

Vsupply: $V_{CC} = 0$ V, $V_{EE} = -2.375$ V to -3.8 V

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
I _{EE}	Supply internal current	Absolute value of current	–40°C, 25°C, 85°C	40		90	mA
I _{CC}	Output and internal supply current	All outputs terminated 50 Ω to V _{CC} – 2 V	–40°C			354	mA
			25°C			380	
			85°C			405	
I _{IN}	Input current	Includes pullup/pulldown resistors V _{IH} = V _{CC} , V _{IL} = V _{CC} - 2 V	–40°C, 25°C, 85°C	–150		150	μA
V _{BB}	Internally generated bias voltage	For V _{EE} = –3 to –3.8 V, I _{BB} = –0.2 mA	–40°C, 25°C, 85°C	–1.45	–1.3	–1.15	V
		V _{EE} = –2.375 to –2.75 V, I _{BB} = –0.2 mA	–40°C, 25°C, 85°C	–1.4	–1.25	–1.1	
V _{ID}	Input amplitude (CLKn, $\overline{\text{CLKn}}$)	Difference of input V _{IH} – V _{IL} , See ⁽¹⁾	-40°C, 25°C, 85°C	0.5		1.3	V
V _{CM}	Common-mode voltage (CLKn, $\overline{\text{CLKn}}$)	DC offset relative to V _{EE}	-40°C, 25°C, 85°C	V _{EE} + 1		–0.3	V

(1) V_{ID} minimum and maximum is required to maintain ac specifications, actual device function tolerates a minimum V_{ID} of 100 mV.

LVECL DC ELECTRICAL CHARACTERISTICS (continued)Vsupply: $V_{CC} = 0\text{ V}$, $V_{EE} = -2.375\text{ V}$ to -3.8 V

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
V_{OH}	High-level output voltage	$I_{OH} = -21\text{ mA}$	-40°C	-1.26		-0.85	V
			25°C	-1.2		-0.85	
			85°C	-1.15		-0.85	
V_{OL}	Low-level output voltage	$I_{OL} = -5\text{ mA}$	-40°C	-1.85		-1.5	V
			25°C	-1.85		-1.45	
			85°C	-1.85		-1.4	
V_{OD}	Differential output voltage swing	Terminated with $50\ \Omega$ to $V_{CC} - 2\text{ V}$, See Figure 3	-40°C 25°C , 85°C	600			mV

LVPECL DC ELECTRICAL CHARACTERISTICSVsupply: $V_{CC} = 2.375\text{ V}$ to 3.8 V , $V_{EE} = 0\text{ V}$

over operating free-air temperature range (unless otherwise noted)

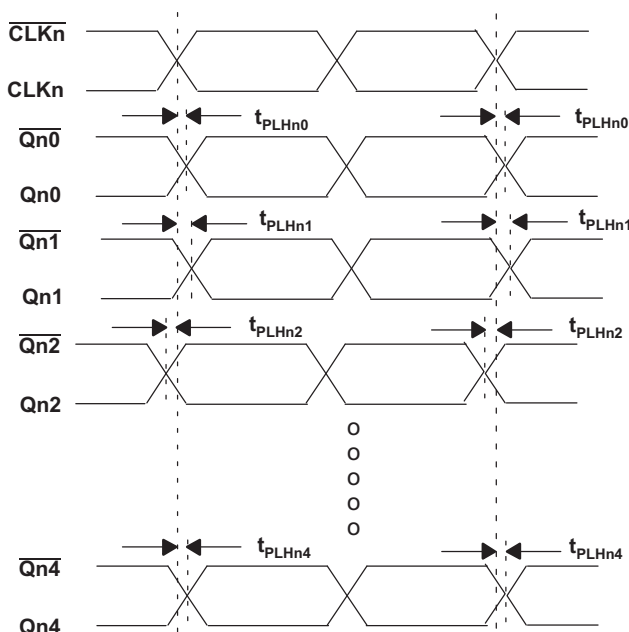
PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
I_{EE}	Supply internal current	Absolute value of current	-40°C , 25°C , 85°C	40		90	mA
I_{CC}	Output and internal supply current	All outputs terminated $50\ \Omega$ to $V_{CC} - 2\text{ V}$	-40°C			354	mA
			25°C			380	
			85°C			405	
I_{IN}	Input current	Includes pullup/pulldown resistors $V_{IH} = V_{CC}$, $V_{IL} = V_{CC} - 2\text{ V}$	-40°C , 25°C , 85°C	-150		150	μA
V_{BB}	Internally generated bias voltage	$V_{CC} = 3\text{ to }3.8\text{ V}$, $I_{BB} = -0.2\text{ mA}$	-40°C , 25°C , 85°C	$V_{CC} - 1.45$	$V_{CC} - 1.3$	$V_{CC} - 1.15$	V
		$V_{CC} = 2.375\text{ to }2.75\text{ V}$, $I_{BB} = -0.2\text{ mA}$	-40°C , 25°C , 85°C	$V_{CC} - 1.4$	$V_{CC} - 1.25$	$V_{CC} - 1.1$	
V_{ID}	Input amplitude (CLKn, $\overline{\text{CLKn}}$)	Difference of input $ V_{IH} - V_{IL} $, see ⁽¹⁾	-40°C , 25°C , 85°C	0.5		1.3	V
V_{CM}	Common-mode voltage (CLKn, $\overline{\text{CLKn}}$)	DC offset relative to V_{EE}	-40°C , 25°C , 85°C	1		$V_{CC} - 0.3$	V
V_{OH}	High-level output voltage	$I_{OH} = -21\text{ mA}$	-40°C	$V_{CC} - 1.26$		$V_{CC} - 0.85$	V
			25°C	$V_{CC} - 1.2$		$V_{CC} - 0.85$	
			85°C	$V_{CC} - 1.15$		$V_{CC} - 0.85$	
V_{OL}	Low-level output voltage	$I_{OL} = -5\text{ mA}$	-40°C	$V_{CC} - 1.85$		$V_{CC} - 1.5$	V
			25°C	$V_{CC} - 1.85$		$V_{CC} - 1.45$	
			85°C	$V_{CC} - 1.85$		$V_{CC} - 1.4$	
V_{OD}	Differential output voltage swing	Terminated with $50\ \Omega$ to $V_{CC} - 2\text{ V}$	-40°C , 25°C , 85°C	600			mV

(1) V_{ID} minimum and maximum is required to maintain ac specifications, actual device function tolerates a minimum V_{ID} of 100 mV.

AC ELECTRICAL CHARACTERISTICS

V_{supply}: V_{CC} = 2.375 V to 3.8 V, V_{EE} = 0 V or LVECL/LVPECL input V_{CC} = 0 V, V_{EE} = -2.375 V to -3.8 V
over operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _{pd}	Differential propagation delay CLKn, $\overline{\text{CLKn}}$ to all QA0, QA0... QB4, QB4	135		300	ps
t _{sk(o)}	Output-to-output skew		15	30	ps
t _{sk(pp)}	Part-to-part skew			70	ps
t _{aj}	Additive phase jitter, rms			< 0.8	ps
f _(max)	Maximum frequency			3500	MHz
t _r /t _f	Output rise and fall time (20%, 80%)	90		200	ps



- Output skew is calculated as the greater of: The difference between the fastest and the slowest t_{PLHn} ($n = n0, n1, \dots, n4$) or the difference between the fastest and the slowest t_{PHLn} ($n = n0, n1, \dots, n4$).
- Part-to-part skew, is calculated as the greater of: The difference between the fastest and the slowest t_{PLHn} ($n = n0, n1, \dots, n4$) across multiple devices or the difference between the fastest and the slowest t_{PHLn} ($n = n0, n1, \dots, n4$) across multiple devices.
- Output skew is measured per the output group.

Figure 1. Waveform for Calculating Both Output and Part-to-Part Skew

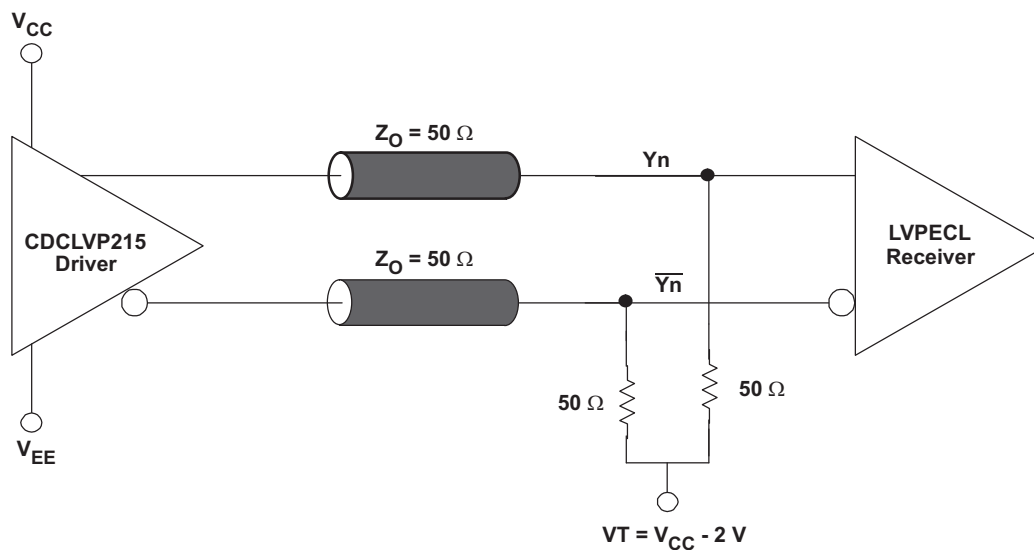


Figure 2. Typical Termination for Output Driver (See the Application Note *Interfacing Between LVPECL, LVDS, and CML*, Literature Number [SCAA056](#))

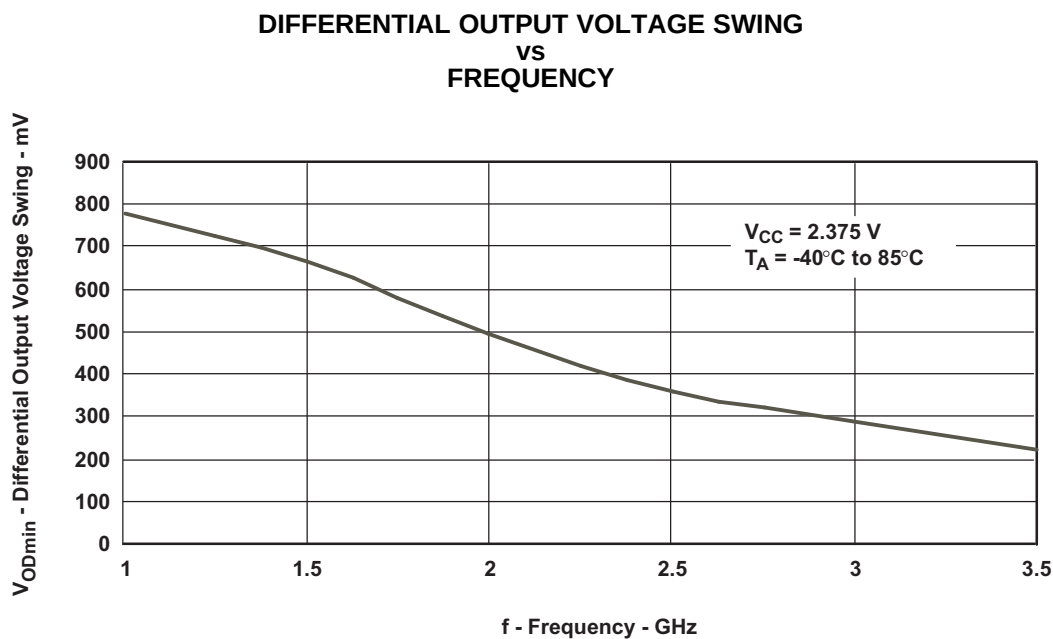


Figure 3. LVPECL Input Using CLKB Pair, $V_{CM} = 1\text{ V}$, $V_{ID} = 0.5\text{ V}$

REVISION HISTORY

Changes from Original (April 2008) to Revision A	Page
• Changed Status from: Product Preview To: Production	1
• Changed Features bullet From: Fully Compatible With LVPECL/LVPECL To: Fully Compatible With LVPECL/LVECL	1
• Changed Features Bullet From: Single Supply Voltage Required ± 3.3 V or ± 2.5 V Supply To: Supports a Wide Supply Voltage Range From 2.375 V to 3.8 V	1
• Deleted PTN1111 from The Pin-to-Pin Features bullet	1
• Changed EP210 in The Pin-to-Pin Features bullet From: EP210 to LVEP210.	1
• Added Application bullet: High Performance Clock Distribution	1
• Changed paragraph - From: The bottom of the QFN32 To: The PowerPAD™ of the QFN32... ..	2
• Changed list item From: $\overline{\text{CLKn}}$ pull up resistor 31.4 k Ω To: $\overline{\text{CLKn}}$ pull up resistor 37.5 k Ω	2
• Changed Abs Max table - Negative supply voltage value From -0.3 to 4.6 To: -4.6 to 0.3	3
• Changed PACKAGE THERMAL IMPEDANCE max values.	3
• Changed LVECL DC ELECTRICAL CHARACTERISTICS values.	3
• Added to the input current Test Conditions: $V_{IH} = V_{CC}$, $V_{IL} = V_{CC} - 2V$	3
• Changed From: Cross point of input 9 average (V_{IH} , V_{IL}) To: DC offset relative to V_{EE}	3
• Changed LVPECL DC ELECTRICAL CHARACTERISTICS values.	4
• Added to the input current Test Conditions: $V_{IH} = V_{CC}$, $V_{IL} = V_{CC} - 2V$	4
• Changed From: Cross point of input 9 average (V_{IH} , V_{IL}) To: DC offset relative to V_{EE}	4
• Changed AC ELECTRICAL CHARACTERISTICS values.	5
• Changed From: Cycle to Cycle RMS jitter To: Additive phase jitter.	5
• Changed Output rise and fall time (20%, 80%) MIN Value From: 100 To: 90	5
Changes from Revision A (October 2008) to Revision B	Page
• Added PowerPAD information to the Pinout Package	1
• Added PowerPAD information to the Pin Functions table	2
• Deleted The PowerPAD™ of the QFN32	2

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
CDCLVP215RHBR	Active	Production	VQFN (RHB) 32	3000 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	LVP215
CDCLVP215RHBR.B	Active	Production	VQFN (RHB) 32	3000 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	LVP215
CDCLVP215RHBT	Active	Production	VQFN (RHB) 32	250 SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	LVP215
CDCLVP215RHBT.B	Active	Production	VQFN (RHB) 32	250 SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	LVP215
CDCLVP215RHBTG4	Active	Production	VQFN (RHB) 32	250 SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	LVP215
CDCLVP215RHBTG4.B	Active	Production	VQFN (RHB) 32	250 SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	LVP215

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

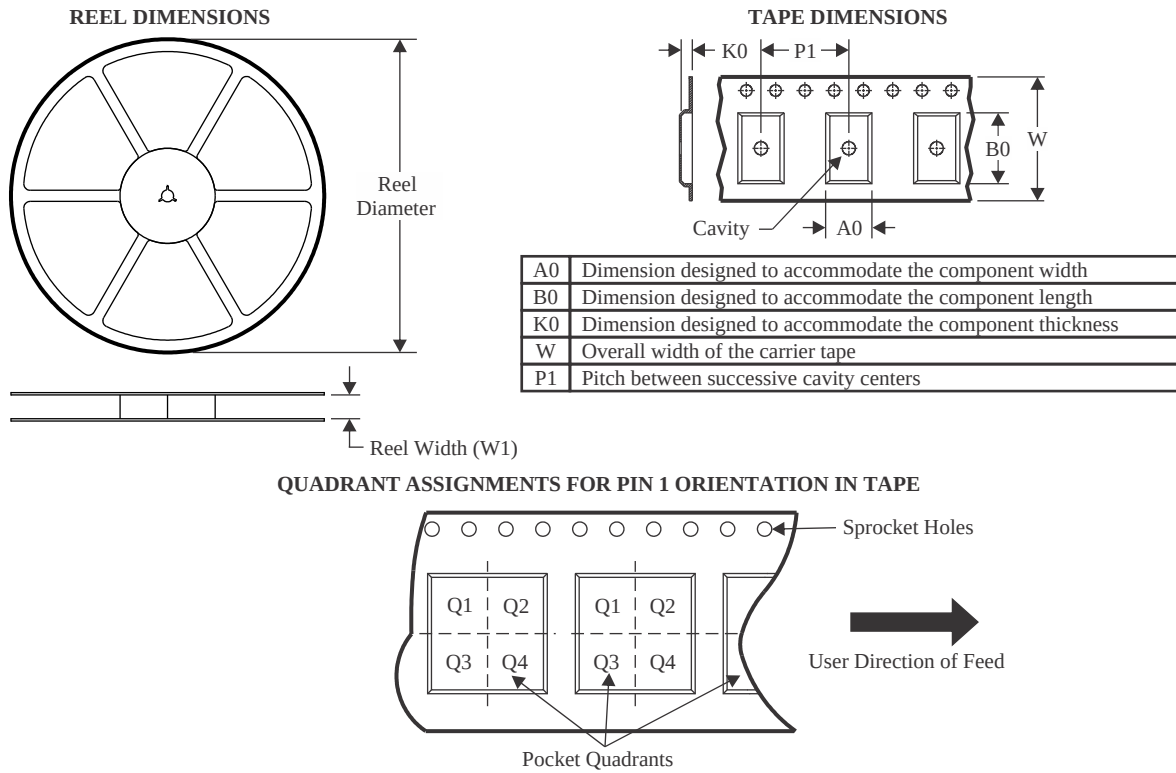
⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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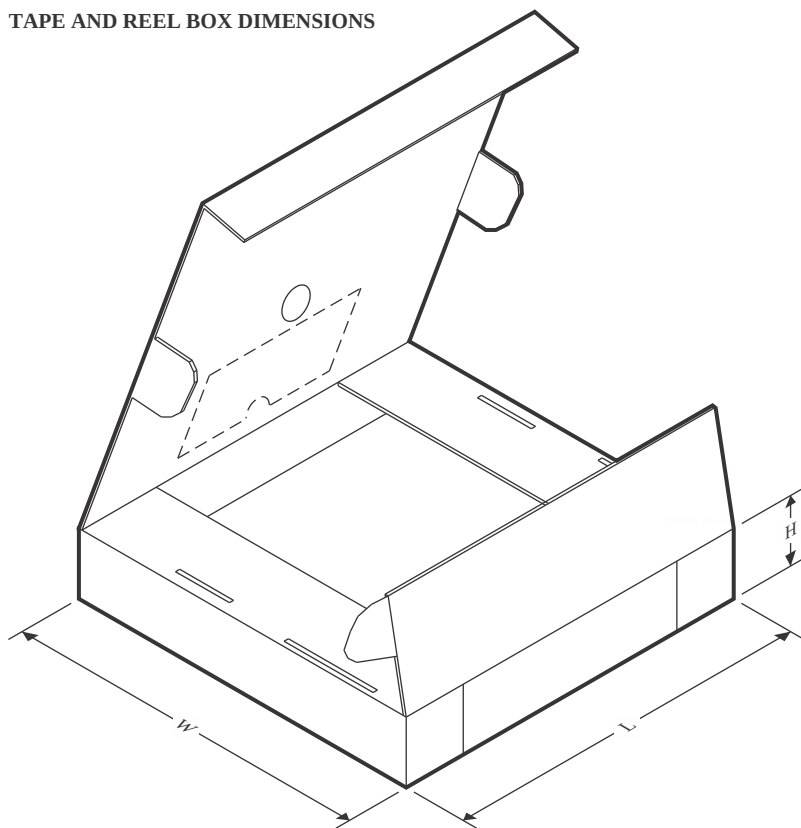
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TAPE AND REEL INFORMATION


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CDCLVP215RHBR	VQFN	RHB	32	3000	330.0	12.4	5.3	5.3	1.5	8.0	12.0	Q2

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CDCLVP215RHBR	VQFN	RHB	32	3000	350.0	350.0	43.0

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